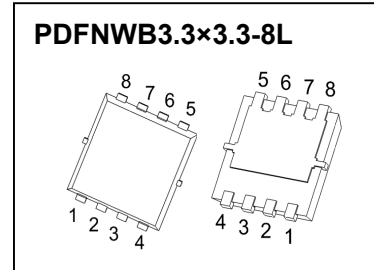


CJAB25N04S N-Channel Power MOSFET

V_{(BR)DSS}	R_{DS(on)MAX}	I_D
40V	9.4mΩ@10V	25A
	15mΩ@4.5V	



DESCRIPTION

The CJAB25N04S uses advanced trench technology and design to provide excellent R_{DS(ON)} with low gate charge. It can be used in a wide variety of applications

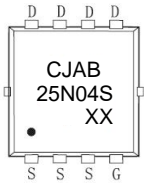
FEATURES

- High Power and current handing capability
- Load switch
- High density cell design for ultra low R_{DS(ON)}
- Lead free product is acquired
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

APPLICATIONS

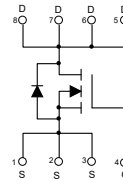
- SMPS and general purpose applications
- Hard switched and high frequency circuits
- Uninterruptible Power Supply
- Power management

MARKING



CJAB25N04S = Part No.
 Solid dot=Pin1 indicator
 XX=Date Code

EQUIVALENT CIRCUIT



MAXIMUM RATINGS (T_a=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	40	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current	I _D	25	A
Pulsed Drain Current	I _{DM}	110	A
Single Pulsed Avalanche Energy	E _{AS} ⁽¹⁾	120	mJ
Power Dissipation	P _D	3	W
Thermal Resistance from Junction to Ambient	R _{θJA}	41.67	°C/W
Junction Temperature	T _J	150	°C
Storage Temperature Range	T _{stg}	-55 ~+150	°C
Lead Temperature for Soldering Purposes(1/8" from case for 10s)	T _L	260	°C

(1).E_{AS} condition: V_{DD}=15V,L=0.1mH, R_G=25Ω, Starting T_J = 25°C

(2).Mounted on a glass epoxy board of 25.4 mm x 25.4 mm x 0.8 mmt

MOSFET ELECTRICAL CHARACTERISTICS

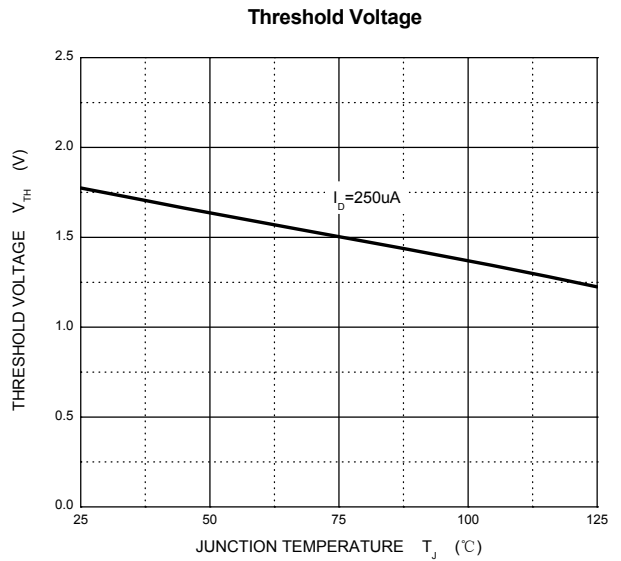
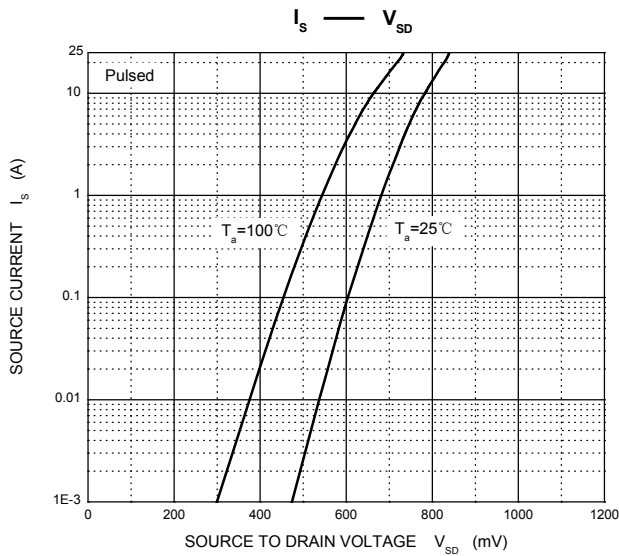
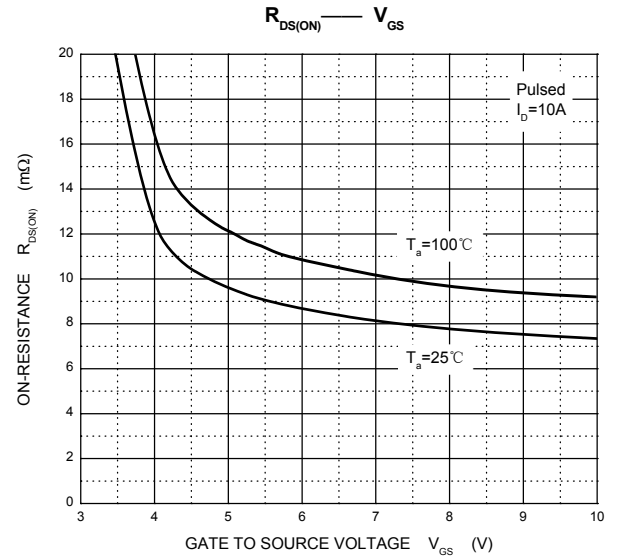
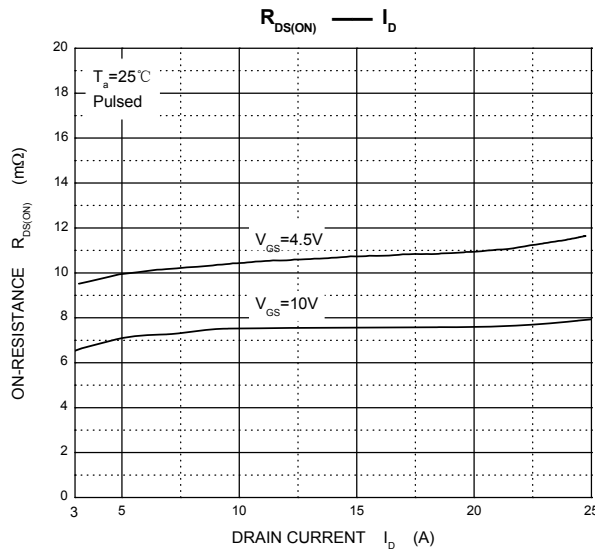
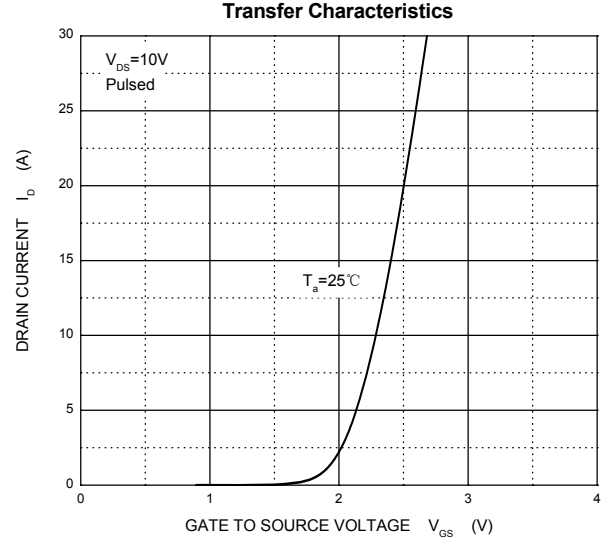
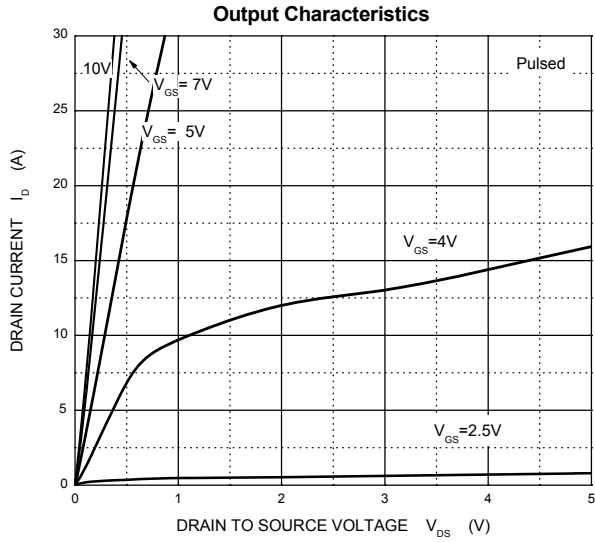
$T_a=25^\circ\text{C}$ unless otherwise specified

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Off characteristics						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	40			V
Zero gate voltage drain current	I_{DSS}	$V_{DS} = 30V, V_{GS} = 0V$			1	μA
Gate-body leakage current	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$			± 100	nA
On characteristics (note1)						
Gate-threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1.0	1.7	2.5	V
Static drain-source on-state resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 10A$		7.5	9.4	$m\Omega$
		$V_{GS} = 4.5V, I_D = 10A$		10.5	15	$m\Omega$
Forward transconductance	g_{fs}	$V_{DS} = 10V, I_D = 2A$		15		S
Dynamic characteristics (note 2)						
Input capacitance	C_{iss}	$V_{DS} = 25V, V_{GS} = 0V,$ $f = 1MHz$		1200		pF
Output capacitance	C_{oss}			124		
Reverse transfer capacitance	C_{rss}			58		
Switching characteristics (note 2)						
Total gate charge	Q_g	$V_{DS} = 20V, V_{GS} = 10V,$ $I_D = 10A$		20.3		nC
Gate-source charge	Q_{gs}			3.2		
Gate-drain charge	Q_{gd}			5.0		
Turn-on delay time	$t_{d(on)}$	$V_{DS} = 15V, I_D = 10A,$ $V_{GS} = 10V, R_G = 3\Omega$		12.7		ns
Turn-on rise time	t_r			2.7		
Turn-off delay time	$t_{d(off)}$			57		
Turn-off fall time	t_f			4.8		
Drain-Source Diode Characteristics						
Drain-source diode forward voltage(note1)	V_{SD}	$V_{GS} = 0V, I_S = 10A$			1.2	V
Continuous drain-source diode forward current	I_S				25	A
Pulsed drain-source diode forward current	I_{SM}				100	A

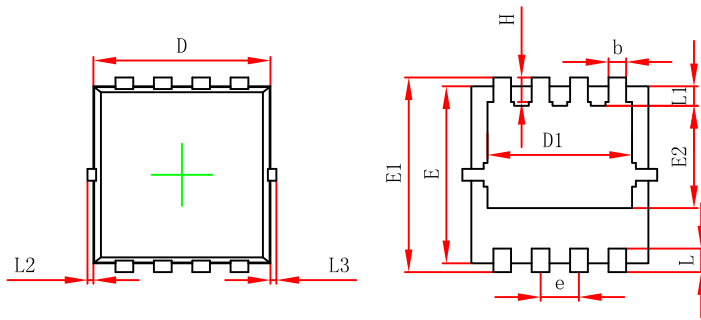
Notes:

1. Pulse Test : Pulse Width $\leq 300\mu s$, duty cycle $\leq 2\%$.
2. Guaranteed by design, not subject to production.

Typical Characteristics

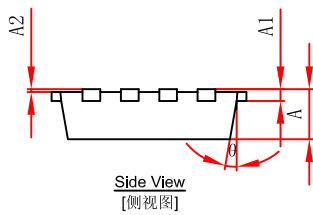


PDFNWB3.3x3.3-8L Package Outline Dimensions



Top View
[顶视图]

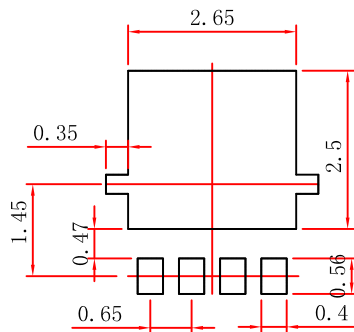
Bottom View
[背视图]



Side View
[侧视图]

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.650	0.850	0.026	0.033
A1	0.152 REF.		0.006 REF.	
A2	0-0.05		0-0.002	
D	2.900	3.100	0.114	0.122
D1	2.300	2.600	0.091	0.102
E	2.900	3.100	0.114	0.122
E1	3.150	3.450	0.124	0.136
E2	1.535	1.935	0.060	0.076
b	0.200	0.400	0.008	0.016
e	0.550	0.750	0.022	0.030
L	0.300	0.500	0.012	0.020
L1	0.180	0.480	0.007	0.019
L2	0-0.100		0-0.004	
L3	0-0.100		0-0.004	
H	0.315	0.515	0.012	0.020
θ	9°	13°	9°	13°

PDFNWB3.3x3.3-8L Suggested Pad Layout



Note:

1. Controlling dimension: in millimeters.
2. General tolerance: ± 0.05 mm.
3. The pad layout is for reference purposes only.

NOTICE

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